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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/054,554	01/18/2002	Mike Ming Yu Chen	SJO920000203US1	7317
7590 05/20/2004			EXAMINER	
Ron Feece INTERNATIONAL BUSINESS MACHINES CORPORATION Dept. L2PA			OLSON, JASON C	
			ART UNIT	PAPER NUMBER
5600 Cottle Road			2651	
San Jose, CA	95193		DATE MAILED: 05/20/2004	3

Please find below and/or attached an Office communication concerning this application or proceeding.

	A It - At on No	
	Application No.	Applicant(s)
Office Action Summary	10/054,554	CHEN ET AL.
Office Action Summary	Examiner	Art Unit
The MAILING DATE of this communication app	Jason C Olson	2651
Period for Reply	ears on the cover sheet with the c	orrespondence address
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).
Status		
1)	action is non-final.	
Disposition of Claims		
4) ☐ Claim(s) 1-27 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) ☐ Claim(s) 12-20 is/are allowed. 6) ☐ Claim(s) 1.2,4,6,7,9 and 21-26 is/are rejected. 7) ☐ Claim(s) 3.5,8,10-11 and 27 is/are objected to 8) ☐ Claim(s) are subject to restriction and/or	vn from consideration.	
Application Papers		
9) ☐ The specification is objected to by the Examine 10) ☑ The drawing(s) filed on 18 January 2002 is/are: Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) ☐ The oath or declaration is objected to by the Ex	a) accepted or b) ⊠objected or b) lobjected o	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applicati rity documents have been receive u (PCT Rule 17.2(a)).	ion No ed in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892)	4) 🔲 Interview Summary	
 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 2. 	Paper No(s)/Mail Di 5) Notice of Informal F 6) Other:	ate Patent Application (PTO-152)

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DETAILED ACTION

Drawings

The drawings are objected to as failing to comply with 37 CFR 1.84(p)(4) because reference character "126" has been used to designate both third insulation layer and pole piece layer. A proposed drawing correction or corrected drawings are required in reply to the Office action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1 and 6 are rejected under 35 U.S.C. 102(e) as being anticipated by Hossain et al. (U.S. 6,296,955).

Regarding claim 1, Hossain et al. teaches an MR and inductive transducer including a write gap layer (item 52, figure 5) between a first NiFe (Nickel-Iron) alloy write pole (item 50) and a second NiFe alloy write pole (item 60); the NiFe alloy is a body-centered cubic (BCC) and contains a percentage of iron (see col. 3, ln. 26-40; col. 4, ln. 39-col. 5, ln. 26; differences in concentration are not patentable because it is not inventive to discover the optimum or workable

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ranges by routine experimentation, see In re Aller, 220 F.2d 454, 456, 105 USPQ 233, 235 CPA 1955)).

Regarding claim 6: claim 6 has limitations similar to those treated in the above rejection and is met by the references as discussed above. Claim 6 however also recites the following limitations as disclosed by Hossain et al. a magnetic sensor (item 46, figure 5) between a first read gap (item 44) and a second read gap (item 46), where the read gaps are sandwiched between a first shield layer (item 42) and a second shield layer (item 50) (see col. 4, ln. 39-col. 5, ln. 26).

Claim 21-26 are rejected under 35 U.S.C. 102(e) as being anticipated by Dinan et al. (U.S. 6,724,571).

Regarding claims 21 and 24, Dinan et al. teaches the fabrication of a write head portion of a magnetic head upon a wafer (or substrate) by depositing a first seed layer of NiFe (nickeliron) followed by electroplating with NiFe having a different magnetic property a first magnetic pole; thereafter a write gap layer is deposited over the first magnetic pole; a seed layer of NiFe is deposited over the write gap and the second magnetic pole is formed by electroplating NiFe having a different magnetic property over the seed layer with (see col. 3, ln. 66-col. 4, ln. 50; It is understood by an artisian in the art that the ferromagnetic material or NiFe have a saturation flux density and it is interpreted by the examiner through the cited text that the saturation flux densities of the electroplating layers is not greater than the saturation flux density of the seed layers).

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Regarding claims 22, 23, and 25: differences in concentration are not patentable because it is not inventive to discover the optimum or workable ranges by routine experimentation, see In re Aller, 220 F.2d 454, 456, 105 USPQ 233, 235 CPA 1955).

Regarding claim 26, Dinan et al. further teaches the process of fabricating wherein a magnetic metallic seed-layer is first deposited over the wafer surface by sputtering or evaporation (see col. col. 4, ln. 51-55).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 2, 4, 7, and 9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hossain et al.

Regarding claims 2 and 7, Hossain et al. teaches a seed layer (item 64, figure 5) underlying an electroplated layer (item 66). (see col. 3, ln. 26-40 and col. 5, ln. 24-27; it is obvious to one of ordinary skill in the art that each layer has a saturation flux density and furthermore it appears in figure 5 and col. 5, ln. 41-54 that the electroplated layer has a saturation flux density no greater than the seed layer flux density.

Regarding claims 4 and 9, Hossain et al. further teaches a seed layer comprising the material NiFe (see col. 5, ln. 14-16).

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Allowable Subject Matter

Claims 12-20 are allowed. The Examiner interprets independent claim 12 as a "means-plus-function" claim under 35 U.S.C §112, Paragraph 6. Claim(s) 12-20 are interpreted to cover the corresponding structure, material, or acts in the specification and equivalents thereof.

Claims 3, 5, 8, 10-11, and 27 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Shi et al. (U.S. 6,221,218) is cited for forming an inductive write head for magnetic data storage media. Cohen (U.S. 6,195,232) is cited for thin film head with solenoid coil.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jason C Olson whose telephone number is 703.305.8325. The examiner can normally be reached on Monday thru Thursday 7:30-5:30; alternate Fridays.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David R Hudspeth can be reached on (703)308-4825. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

May 4, 2004

DAVID HUDSPETH SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2600

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